Industry, National Programs, Technology access

   * Roadmap of processes and technologies that will be available/used in the next 10 years.

  * MPR sharing, changes in minimum orders, access to PDK's and standard cell libraries.

   * Current and future IC design organization in other countries with any insights and recommendations about interfacing to funding agencies and IC foundries over the next 10 years.

   * Retention, training and coordination of designers and resources.

  * Community access to specialists, workshops to share IP, circuit techniques and specialized
     CAD solutions that may be unique to HEP and Nuclear physics designs.

    * Repositories (if they exist) for sharing CAD tool experience, scripts etc.,   foundry checking issues?

     * Process availability and selection, concerning longevity, technical appropriateness, cost and related complexity of the CAD tools.